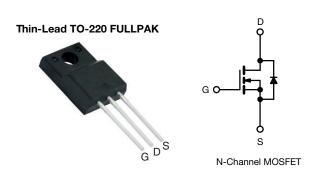


www.vishay.com

Vishay Siliconix

HALOGEN

E Series Power MOSFET



PRODUCT SUMMARY		
V _{DS} (V) at T _J max.	65	0
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.60
Q _g max. (nC)	12	2
Q _{gs} (nC)	3	
Q _{gd} (nC)	3	
Configuration	Sing	gle

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA690N60E-GE3

ABSOLUTE MAXIMUM RATINGS PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	600		
Gate-source voltage		V _{GS}	± 30	- V	
Continuous drain augrent /T 150 °C\ 6	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	1	4.3	
Continuous drain current (T _J = 150 °C) ^e	V _{GS} at 10 V	T _C = 100 °C	I _D	2.7	А
Pulsed drain current ^a			I _{DM}	11	
Linear derating factor			0.23	W/°C	
Single pulse avalanche energy b		E _{AS}	9	mJ	
Maximum power dissipation		P_{D}	29	W	
Operating junction and storage temperature rai	nge		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		T _J = 125 °C	al / al.	70	V/ns
Reverse diode dv/dt ^d			dv/dt	17	V/IIS
Soldering recommendations (peak temperature	e) c	For 10 s		260	°C
Mounting torque, M3 screw			0.6	Nm	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 0.8 A
- c. 1.6 mm from case
- d. $I_{SD} \leq I_D$, di/dt = 100 A/ μ s, starting $T_J = 25~^{\circ}C$
- e. Limited by maximum junction temperature

\$19-0493-Rev. A, 17-Jun-2019 **1** Document Number: 92275



www.vishay.com

Vishay Siliconix

THERMAL RESISTANCE RAT	INGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	4.3	C/VV

SPECIFICATIONS (T _J = 25 °C, t	inless otherwi	ise noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Octo commo lockers		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zana sata waltana duaka awasat	,	V _{DS} =	: 600 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.0 A	-	0.60	0.70	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 20 V, I _D = 2.0 A	-	1.2	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	347	-	
Output capacitance	C _{oss}	Ţ,	$V_{DS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		24	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	4	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V 0VV 400V V 0V		-	17	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		86	-	
Total gate charge	Qg			-	8	12	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 2.0 \text{ A}, V_{DS} = 480 \text{ V}$	-	3	-	nC
Gate-drain charge	Q _{gd}			-	3	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, I_{D} = 2.0 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	12	24	
Rise time	t _r			-	9	18	no
Turn-off delay time	t _{d(off)}			-	19	38	ns
Fall time	t _f			-	22	44	
Gate input resistance	R_g	f = 1 MHz, open drain		1.1	2.3	4.6	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	6.4	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	11	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 2.0 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	146	292	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}$, $I_F = I_S = 2.0 \text{A}$, $I_F = 100 \text{A/}\mu\text{s}$, $I_F = 25 \text{V}$		-	1.0	2.0	μC
Reverse recovery current	I _{RRM}			-	13	_	A

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

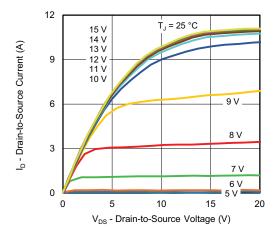


Fig. 1 - Typical Output Characteristics

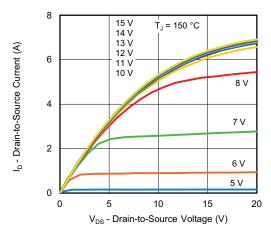


Fig. 2 - Typical Output Characteristics

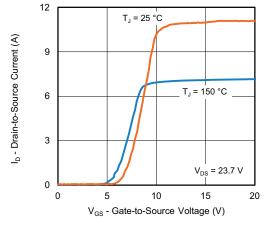


Fig. 3 - Typical Transfer Characteristics

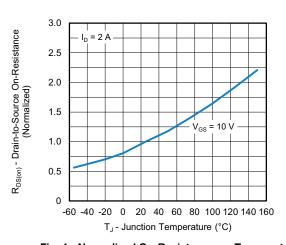


Fig. 4 - Normalized On-Resistance vs. Temperature

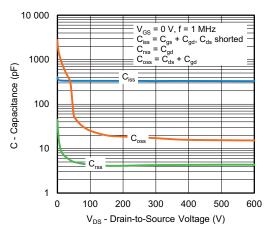


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

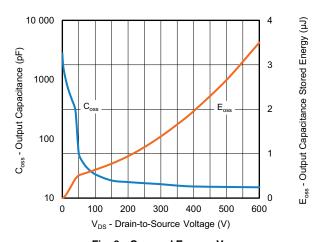


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S19-0493-Rev. A, 17-Jun-2019 **3** Document Number: 92275



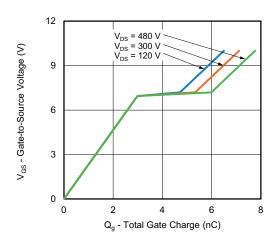


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

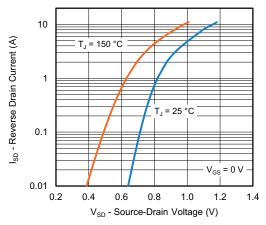


Fig. 8 - Typical Source-Drain Diode Forward Voltage

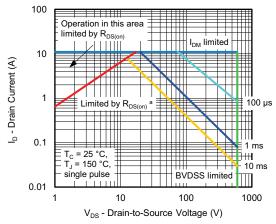


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

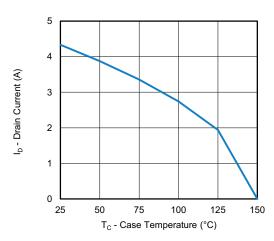


Fig. 10 - Maximum Drain Current vs. Case Temperature

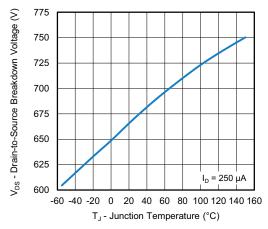


Fig. 11 - Temperature vs. Drain-to-Source Voltage



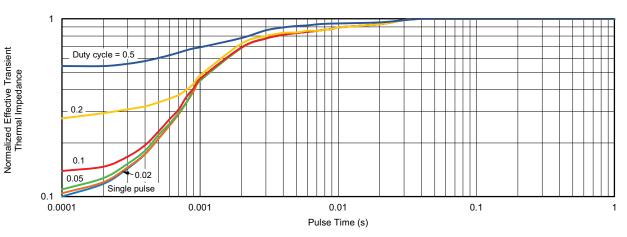


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

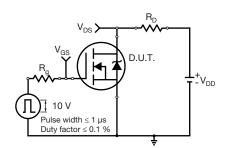


Fig. 13 - Switching Time Test Circuit

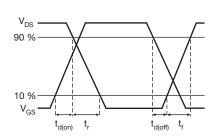


Fig. 14 - Switching Time Waveforms

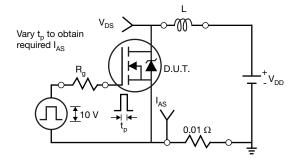


Fig. 15 - Unclamped Inductive Test Circuit

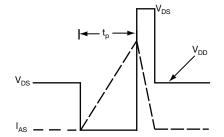


Fig. 16 - Unclamped Inductive Waveforms

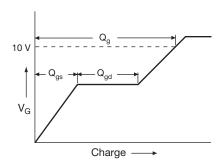


Fig. 17 - Basic Gate Charge Waveform

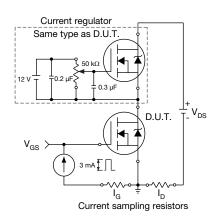
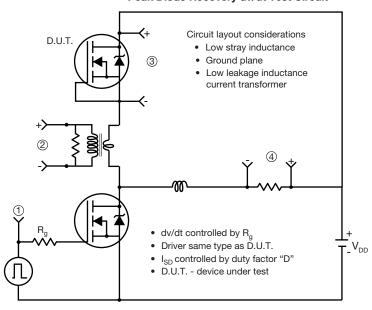


Fig. 18 - Gate Charge Test Circuit

Document Number: 92275



Peak Diode Recovery dv/dt Test Circuit



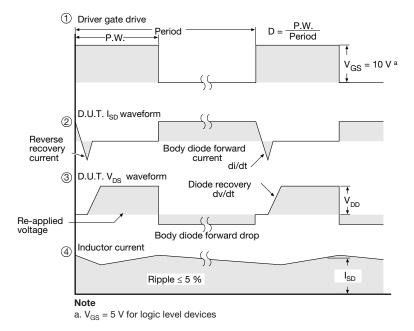


Fig. 19 - For N-Channel

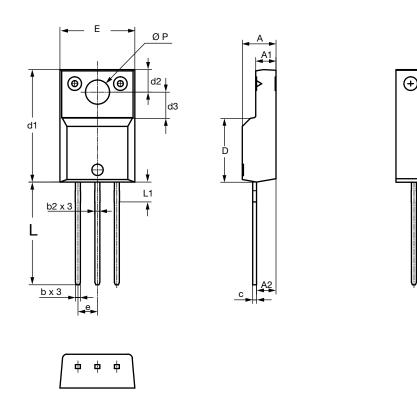
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92275.

S19-0493-Rev. A, 17-Jun-2019 Document Number: 92275



Vishay Siliconix

TO-220 FULLPAK Thin Lead



SYMBOL	DIMENSIONS				
	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	-	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
E	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØΡ	3.00	3.40	0.118	0.134	

Revision: 28-Dec-2020 1 Document Number: 62649

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2022 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED